

PATENT ASSIGNMENT COVER SHEET

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 Stylesheet Version v1.2

EPAS ID: PAT3822337

SUBMISSION TYPE:	NEW ASSIGNMENT	
NATURE OF CONVEYANCE:	ASSIGNMENT	
CONVEYING PARTY DATA		
	Name	Execution Date
	TSEUNG-YUEN TSENG	03/16/2016
	TSUNG-LING TSAI	03/16/2016
	FA-SHEN JIANG	03/11/2016
RECEIVING PARTY DATA		
Name:	WINBOND ELECTRONICS CORP.	
Street Address:	NO. 8 KEYA 1ST RD., DAYA DISTRICT, CENTRAL TAIWAN SCIENCE PARK,	
City:	TAICHUNG CITY	
State/Country:	TAIWAN	
PROPERTY NUMBERS Total: 1		
	Property Type	Number
	Application Number:	15084149
CORRESPONDENCE DATA		
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ATTORNEY DOCKET NUMBER:	0941/3214PUS1	
NAME OF SUBMITTER:	JOE MCKINNEY MUNCY	
SIGNATURE:	/JOE MCKINNEY MUNCY/	
DATE SIGNED:	04/08/2016	
Total Attachments: 1		
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ASSIGNMENT

WHEREAS, Tseung-Yuen TSENG, Tsung-Ling TSAI and Fa-Shen JIANG hereafter referred to as ASSIGNOR, has/have invented certain new and useful improvements as described and set forth in the below identified application for United States Letters Patent:

Title: CONDUCTIVE-BRIDGING RANDOM ACCESS MEMORY

Filed: _____ Serial No. _____
Executed on: _____

WHEREAS, Winbond Electronics Corp. of No. 8 Keya 1st Rd., Daya District, Central Taiwan Science Park, Taichung City, Taiwan, R.O.C. hereinafter referred to as ASSIGNEE, is desirous of acquiring ASSIGNOR'S interest in the said invention and application and in any U.S. Letters Patent which may be granted on the same;

NOW, THEREFORE, TO ALL WHOM IT MAY CONCERN: Be it known that, for good and valuable consideration, receipt of which is hereby acknowledged by Assignor, Assignor has/have sold, assigned and transferred, and by these presents does/do sell, assign and transfer unto the said Assignee, and Assignee's successors and assigns, all his/her/their rights, title and interest in and to the said invention and application and all future improvements thereon, and in and to any Letters Patent which may hereafter be granted on the same in the United States, the said interest to be held and enjoyed by said Assignee as fully and exclusively as it would have been held and enjoyed by said Assignor had this Assignment and transfer not been made, to the full end and term of any Letters Patent which may be granted thereon, or of any division, renewal, continuation in whole or in part, substitution, conversion, reissue, prolongation or extension thereof.

Assignor further agrees/agree that he/she/they will, without charge to said Assignee, but at Assignee's expense, cooperate with Assignee in the prosecution of said application and/or applications, execute, verify, acknowledge and deliver all such further papers, including applications for Letters Patent and for the reissue thereof, and instruments of assignment and transfer thereof, and will perform such other acts as Assignee lawfully may request, to obtain or maintain Letters Patent for said invention and improvement, and to vest title thereto in said Assignee, or Assignee's successors and assigns.

IN TESTIMONY WHEREOF, Assignor has/have signed his/her/their name(s) on the date(s) indicated.

Tseung-Yuen TSENG

March 16, 2016
Date

TSAI, Tsung-Ling
Tsung-Ling TSAI

2016.3.16
Date

JIANG, FA-SHEN
Fa-Shen JIANG

2016.3.11
Date